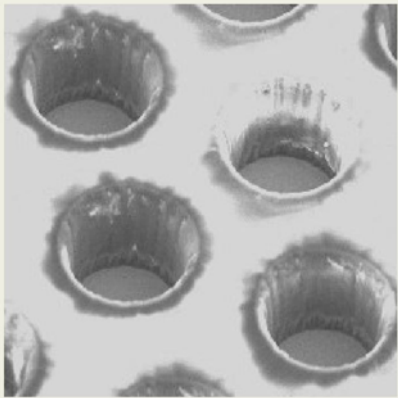
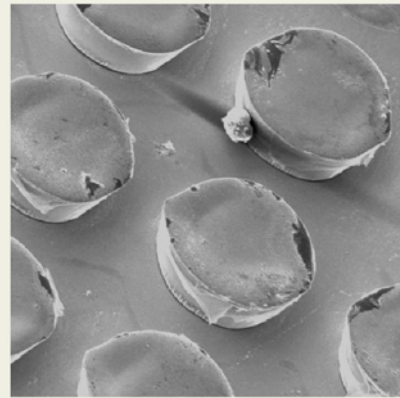


## SIMTech technical reports

Number 3 pp. 122–177 Jul–Sep 2006



KrF excimer laser-drilled  
micro-vias



Electroplated copper bumps

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